

FTG for VIA KT266 Chipset with Programmable Output Frequency

Features

- Single chip FTG solution for VIA KT266 Chipset
- Programmable clock output frequency with less than 1 MHz increment
- · Integrated fail-safe Watchdog timer for system recovery
- Automatically switch to HW selected or SW programmed clock frequency when watchdog timer time-out
- Capable of generate system RESET after a watchdog timer time-out occurs or a change in output frequency via SMBus interface
- Support SMBus byte read/write and block read/ write operations to simplify system BIOS development
- Vendor ID and Revision ID support
- Programmable drive strength for PCI output clocks
- Programmable output skew between CPU, AGP and PCI
- Maximized EMI suppression using Cypress's Spread Spectrum Technology

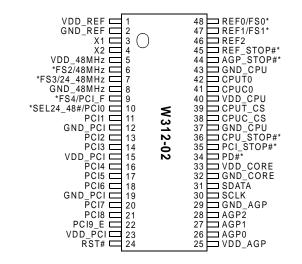
- · Low jitter and tightly controlled clock skew
- Two pairs of differential CPU clocks
- Eleven copies of PCI clocks
- Three copies of 66-MHz outputs
- Two copies of 48-MHz outputs
- Three copies of 14.31818-MHz reference clocks
- · One RESET output for system recovery
- Power management control support

Key Specifications

CPU Outputs Cycle-to-Cycle Jitter:	250 ps
48-MHz, 3V66, PCI Outputs	
Cycle-to-Cycle Jitter:	500 ps
CPU, 3V66 Output Skew:	200 ps
48-MHz Output Skew:	250 ps
PCI Output Skew:	500 ps

Block Diagram -VDD REF XTAL REF1/FS1* ► REF0/FS0* PLL REF FREQ VDD_CPU CPUT0,CPUC0 SDATA **SMBus** Delay, ► CPUT_CS,CPUC_CS and Logic Phase Control VDD_AGP AGP0:2 Logic (FS0:4) VDD PCI PCI0/SEL24 48# PLL 1 PD# CPU_STOP# PCI_STOP# AGP_STOP# RST# REF_STOP# -VDD 48MHz 48MHz/FS3* PLL2 24 48MHz/FS4

Pin Configuration^[1]



Note:

 Internal 100K pull-up resistors present on inputs marked with *. Design should not rely solely on internal pull-up resistor to set I/O pins HIGH.

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Pin Definitions

Pin Name	Pin No.	Pin Type	Pin Description	
REF0/FS0	48	I/O	Reference Clock Output 0/Frequency Select 0: 3.3V 14.318-MHz clock output. REF0 will be disabled when REF_STOP# is active. This pin also serves as the select strap to determines device operating frequency as described in <i>Table 4</i> .	
REF1/FS1	47	I/O	Reference Clock Output 0/Frequency Select 1: 3.3V 14.318-MHz clock output. REF1 will be disabled when REF_STOP# is active. This pin also serves as the select strap to determines device operating frequency as described in <i>Table 4</i> .	
REF2	46	I/O	Reference Clock Output 2: 3.3V 14.318-MHz clock output. REF2 will be disabled when REF_STOP# is active.	
X1	3	-	Crystal Input: This pin has dual functions. It can be used as an external 14.318-MHz crystal connection or as an external reference frequency input.	
X2	4	I	Crystal Output: An input connection for an external 14.318-MHz crystal connection. If using an external reference, this pin must be left unconnected.	
PCI_F/FS4	9	I	Free-Running PCI Clock/Frequency Select 4: 3.3V 33-MHz free running PCI clock output. This pin also serves as the select strap to determines device operating frequency as described in Table 4.	
PCI_0/SEL24_48#	10	I/O	PCI Clock 0/Select 24 or 48 MHz: 3.3V 33-MHz PCI clock outputs. This output will be disabled when PCI_STOP# is active. This pin also serves as the select strap to determine device operating frequency of 24_48MHz output.	
PCI1:8	11, 13, 14, 16, 17, 18, 20, 21	0	PCI Clock 1 through 8: 3.3V 33-MHz PCI clock outputs. PCI1:8 will be disabled when PCI_STOP# is active.	
PCI9_E	22	0	<i>Early PCI Clock 9:</i> 3.3V 33-MHz PCI clock outputs. PCI9_E will be disabled when PCI_STOP# is active.	
AGP0:2	26, 27, 28	0	AGP Clock 0 through 2: 3.3V 66-MHz clock outputs. The operating frequency is controlled by FS0:4 (see <i>Table 4</i>). AGP0:2 will be disabled when AGP_STOP# is active.	
48MHz/FS2	6	I/O	48-MHz Output/Frequency Selection 3: 3.3V 48-MHz non-spread spectrum output. 48MHz will be disabled when REF_STOP# is active. This pin also serves as the select strap to determine device operating frequency as described in <i>Table 4</i> .	
24_48MHz/FS3	7	I/O	24 or 48-MHz Output/Select 24 or 48 MHz: 3.3V 24 or 48-MHz non-spread spectrum output. 24_48MHz will be disabled when REF_STOP# is active. This pin also serves as the select strap to determine device operating frequency as described in <i>Table 4</i> .	
RST#	24	O (open- drain)	Reset#: Open-drain RESET# output.	
CPUT0, CPUC0	42, 41	O (open- drain)	CPU Clock Output 0: CPUT0 and CPUC0 are the differential CPU clock outputs for the K7 processor. They are open-drain outputs.	
CPUT_CS, CPUC_CS	39, 38	0	CPU Clock Output for Chipset: CPUT_CS and CPUC_CS are the differential CPU clock outputs for the chipset. They are push-pull outputs. These outputs will be disabled when CPU_STOP# is active.	
CPU_STOP#	36	I	CPU STOP Input: This input will disable CPUT_CS and CPUC_CS when it is active.	
PCI_STOP#	35	I	PCI STOP Input: This input will disable PCI0:8 and PCI9_E when it is active.	
AGP_STOP#	44	I	AGP STOP Input: This input will disable AGP0:2 when it is active.	
REF_STOP#	45	I	REF STOP Input: This input will disable REF0:2, 24_48MHz and 48 MHz outputs when it is active.	



Pin Definitions (continued)

20	(**************************************	1	
Pin Name	Pin No.	Pin Type	Pin Description
PD#	34	I	Power-Down Input: This input will trigger the clock generator into Power Down mode when it is active.
SDATA	31	I/O	Data pin for SMBus circuitry.
SCLK	30	I	Clock pin for SMBus circuitry.
VDD_CPU	40	Р	2.5V Power Connection: Power supply for CPU output buffers. Connect to 2.5V.
VDDQ_AGP	25	Р	3.3V Power Connection: Power supply for AGP output buffers. Connect to 3.3V.
VDDQ_PCI	15, 23	Р	3.3V Power Connection: Power supply for PCI output buffers. Connect to 3.3V.
VDDQ_48MHz	5	Р	3.3V Power Connection: Power supply for 48 MHz output buffers. Connect to 3.3V.
VDD_REF	1	Р	3.3V Power Connection: Power supply for reference output buffers. Connect to 3.3V.
VDD_Core	33	Р	3.3V Power Connection: Power supply for PLL core. Connect to 3.3V.
GND_REF, GND_48MHz, GND_PCI, GND_AGP, GND_Core, GND_CPU	2, 8, 29, 32, 37, 43	G	Ground Connections: Connect all ground pins to the common system ground plane.



Serial Data Interface

The W312-02 features a two-pin, serial data interface that can be used to configure internal register settings that control particular device functions.

Data Protocol

The clock driver serial protocol supports byte/word write, byte/word read, block write and block read operations from the

controller. For block write/read operation, the bytes must be accessed in sequential order from lowest to highest byte with the ability to stop after any complete byte has been transferred. For byte/word write and byte read operations, system controller can access individual indexed byte. The offset of the indexed byte is encoded in the command code.

The definition for the command code is defined in Table 1.

Bit	Descriptions
7	0 = Block read or block write operation 1 = Byte/Word read or byte/word write operation
6:0	Byte offset for byte/word read or write operation. For block read or write operations, these bits need to be set at '0000000'.

Table 1. Block Read and Block Write Protocol

Block Write Protocol			Block Read Protocol
Bit	Description	Bit	Description
1	Start	1	Start
2:8	Slave address - 7 bits	2:8	Slave address - 7 bits
9	Write	9	Write
10	Acknowledge from slave	10	Acknowledge from slave
11:18	Command Code - 8 bits '00000000' stands for block operation	11:18	Command Code - 8 bits '00000000' stands for block operation
19	Acknowledge from slave	19	Acknowledge from slave
20:27	Byte Count - 8 bits	20	Repeat start
28	Acknowledge from slave	21:27	Slave address - 7 bits
29:36	Data byte 0 - 8 bits	28	Read
37	Acknowledge from slave	29	Acknowledge from slave
38:45	Data byte 1 - 8 bits	30:37	Byte count from slave - 8 bits
46	Acknowledge from slave	38	Acknowledge
	Data Byte N/Slave Acknowledge	39:46	Data byte from slave - 8 bits
	Data Byte N - 8 bits	47	Acknowledge
	Acknowledge from slave	48:55	Data byte from slave - 8 bits
	Stop	56	Acknowledge
			Data bytes from slave/Acknowledge
			Data byte N from slave - 8 bits
			Not Acknowledge
			Stop



Table 2. Word Read and Word Write Protocol

	Word Write Protocol		Word Read Protocol
Bit	Description	Bit	Description
1	Start	1	Start
2:8	Slave address - 7 bits	2:8	Slave address - 7 bits
9	Write	9	Write
10	Acknowledge from slave	10	Acknowledge from slave
11:18	Command Code - 8 bits '1xxxxxxx' stands for byte or word operation bit[6:0] of the command code represents the off- set of the byte to be accessed	11:18	Command Code - 8 bits '1xxxxxxx' stands for byte or word operation bit[6:0] of the command code represents the off- set of the byte to be accessed
19	Acknowledge from slave	19	Acknowledge from slave
20:27	Data byte low- 8 bits	20	Repeat start
28	Acknowledge from slave	21:27	Slave address - 7 bits
29:36	Data byte high - 8 bits	28	Read
37	Acknowledge from slave	29	Acknowledge from slave
38	Stop	30:37	Data byte low from slave - 8 bits
		38	Acknowledge
		39:46	Data byte high from slave - 8 bits
		47	NOT acknowledge
		48	Stop

Table 3. Byte Read and Byte Write Protocol

	Byte Write Protocol		Byte Read Protocol
Bit	Description	Bit	Description
1	Start	1	Start
2:8	Slave address - 7 bits	2:8	Slave address - 7 bits
9	Write	9	Write
10	Acknowledge from slave	10	Acknowledge from slave
11:18	Command Code - 8 bits '1xxxxxxx' stands for byte operation bit[6:0] of the command code represents the off- set of the byte to be accessed	11:18	Command Code - 8 bits '1xxxxxxx' stands for byte operation bit[6:0] of the command code represents the off- set of the byte to be accessed
19	Acknowledge from slave	19	Acknowledge from slave
20:27	Data byte - 8 bits	20	Repeat start
28	Acknowledge from slave	21:27	Slave address - 7 bits
29	Stop	28	Read
		29	Acknowledge from slave
		30:37	Data byte from slave - 8 bits
		38	Not Acknowledge
		39	Stop



W312-02 Serial Configuration Map

 The serial bits will be read by the clock driver in the following order:

Byte 0 - Bits 7, 6, 5, 4, 3, 2, 1, 0

Byte 1 - Bits 7, 6, 5, 4, 3, 2, 1, 0

Byte N - Bits 7, 6, 5, 4, 3, 2, 1, 0

- 2. All unused register bits (reserved and N/A) should be written to a "0" level.
- 3. All register bits labeled "Initialize to 0" must be written to zero during initialization.

Bit	Pin#	Name	Default	Description
Bit 7	-	Spread Enable	0	0 = Disabled
				1 = Enabled
Bit 6	-	Spread Select2	0	'000' = ± 0.25%
Bit 5	-	Spread Select1	0	'001' = -0.5%
Bit 4	-	Spread Select0	0	'010' = ±0.5%
				'011' = ±0.38%
				'100' = Reserved
				'101' = Reserved
				'110' = Reserved
				'111' = Reserved
Bit 3	-	SEL3	0	SW Frequency selection bits. See <i>Table 4</i> .
Bit 2	-	SEL2	0	
Bit 1	-	SEL1	0	
Bit 0	-	SEL0	0	

Bit	Pin#	Name	Default	Description
Bit 7	42, 41	CPUT0, CPUC0	1	(Active/Inactive)
Bit 6	39, 38	CPUT_CS, CPUC_CS	1	(Active/Inactive)
Bit 5	6	48MHz	1	(Active/Inactive)
Bit 4	7	24_48MHz	1	(Active/Inactive)
Bit 3	-	Reserved	0	Reserved
Bit 2	28	AGP2	1	(Active/Inactive)
Bit 1	27	AGP1	1	(Active/Inactive)
Bit 0	26	AGP0	1	(Active/Inactive)



Bit	Pin#	Name	Default	Description
Bit 7	20	PCI7	1	(Active/Inactive)
Bit 6	18	PCI6	1	(Active/Inactive)
Bit 5	17	PCI5	1	(Active/Inactive)
Bit 4	16	PCI4	1	(Active/Inactive)
Bit 3	14	PCI3	1	(Active/Inactive)
Bit 2	13	PCI2	1	(Active/Inactive)
Bit 1	11	PCI1	1	(Active/Inactive)
Bit 0	10	PCI0	1	(Active/Inactive)

Bit	Pin#	Name	Default	Description
Bit 7	9	PCI_F	1	(Active/Inactive)
Bit 6	22	PCI9_E	1	(Active/Inactive)
Bit 5		Reserved	0	Reserved
Bit 4	21	PCI8	1	(Active/Inactive)
Bit 3	46	REF2	1	(Active/Inactive)
Bit 2		Reserved	0	Reserved
Bit 1	47	REF1	1	(Active/Inactive)
Bit 0	48	REF0	1	(Active/Inactive)

Bit	Pin#	Name	Default	Description
Bit 7		Reserved	0	Reserved
Bit 6		FS_Override	0	0 = Select operating frequency by FS[4:0] input pins 1 = Select operating frequency by SEL[4:0] settings
Bit 5		WD_TIMER4	1	These bits store the time-out value of the WATCH-
Bit 4		WD_TIMER3	1	DOG timer. The scale of the timer is determine by the pre-scaler.
Bit 3		WD_TIMER2	1	The timer can support a value of 150 ms to 4.8 sec when the pre-scalar is set to 150 ms. If the pre-scaler
Bit 2		WD_TIMER1	1	is set to 2.5 sec, it can support a value from 2.5 sec to 80 sec.
Bit 1		WD_TIMER0	1	When the Watchdog timer reaches "0", it will set the WD_TO_STATUS bit.
Bit 0		WD_PRE_SCAL ER	0	0 = 150 ms 1 = 2.5 sec

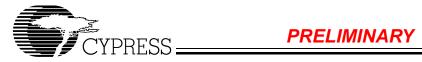


Bit	Pin#	Name	Default	Description
Bit 7	9	Latched FS4 input	Х	Latched FS[4:0] inputs. These bits are read only.
Bit 6	7	Latched FS3 input	Х	
Bit 5	6	Latched FS2 input	Х	
Bit 4	47	Latched FS1 input	Х	
Bit 3	48	Latched FS0 input	Х	
Bit 2		Reserved	0	Reserved
Bit 1		Reserved	0	Reserved
Bit 0		SEL4	0	SW Frequency selection bits. See <i>Table 4</i> .

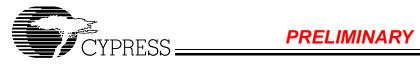
Bit	Name	Default	Pin Description
Bit 7	Reserved	1	Reserved
Bit 6	Reserved	1	Reserved
Bit 5	Reserved	1	Reserved
Bit 4	Reserved	1	Reserved
Bit 3	Reserved	1	Reserved
Bit 2	Reserved	1	Reserved
Bit 1	Reserved	1	Reserved
Bit 0	Reserved	1	Reserved

Bit	Name	Default	Pin Description
Bit 7	Reserved	1	Reserved
Bit 6	Reserved	1	Reserved
Bit 5	Reserved	1	Reserved
Bit 4	Reserved	1	Reserved
Bit 3	Reserved	1	Reserved
Bit 2	Reserved	1	Reserved
Bit 1	Reserved	1	Reserved
Bit 0	Reserved	1	Reserved

Bit	Name	Default	Pin Description
Bit 7	Revision_ID3	0	Revision ID bit[3]
Bit 6	Revision_ID2	0	Revision ID bit[2]
Bit 5	Revision_ID1	0	Revision ID bit[1]
Bit 4	Revision_ID0	0	Revision ID bit[0]
Bit 3	Vendor_ID3	1	Bit[3] of Cypress Semiconductor's Vendor ID. This bit is read only.



Bit	Name	Default	Pin Description
Bit 2	Vendor_ID2	0	Bit[2] of Cypress Semiconductor's Vendor ID. This bit is read only.
Bit 1	Vendor _ID1	0	Bit[1] of Cypress Semiconductor's Vendor ID. This bit is read only.
Bit 0	Vendor _ID0	0	Bit[0] of Cypress Semiconductor's Vendor ID. This bit is read only.



Bit	Name	Default	Pin Description
Bit 7	Reserved	0	Reserved
Bit 6	PCI_DRV	0	PCI clock output drive strength 0 = Normal 1 = High Drive
Bit 5	Reserved	0	Reserved
Bit 4	RST_EN_WD	0	This bit will enable the generation of a Reset pulse when a watchdog timer time-out occurs. 0 = Disabled 1 = Enabled
Bit 3	RST_EN_FC	0	This bit will enable the generation of a Reset pulse after a frequency change occurs. 0 = Disabled 1 = Enabled
Bit 2	WD_TO_STATUS	0	Watchdog Timer Time-out Status bit 0 = No time-out occurs (READ); Ignore (WRITE) 1 = time-out occurred (READ); Clear WD_TO_STATUS (WRITE)
Bit 1	WD_EN	0	0 = Stop and re-load Watchdog timer 1 = Enable Watchdog timer. It will start counting down after a frequency change occurs.
Bit 0	Reserved	0	Reserved

Bit	Name	Default	Description
Bit 7	CPU_Skew2	0	CPU skew control
Bit 6	CPU_Skew1	0	000 = Normal 001 = -150 ps
Bit 5	CPU_Skew0	0	010 = -300 ps 011 = -450 ps 100 = +150 ps 101 = +300 ps 110 = +450 ps 111 = +600 ps
Bit 4	Reserved	0	Reserved
Bit 3	PCI_Skew1	0	PCI skew control
Bit 2	PCI_Skew0	0	00 = Normal 01 = -500 ps 10 = Reserved 11 = +500 ps
Bit 1	AGP_Skew1	0	AGP skew control
Bit 0	AGP_Skew0	0	00 = Normal 01 = -150 ps 10 = +150 ps 11 = +300 ps



Bit	Name	Default	Pin Description
Bit 7	ROCV_FREQ_N7	0	If ROCV_FREQ_SEL is set, W312-02 will use the values programmed in ROCV_FREQ_N[7:0] and ROCV_FREQ_M[6:0] to determine the recovery
Bit 6	ROCV_FREQ_N6	0	CPU output frequency.when a Watchdog timer time-out occurs.
Bit 5	ROCV_FREQ_N5	0	The setting of FS_Override bit determines the frequency ratio for CPU, SDRAM, AGP and SDRAM. When it is cleared, W312-02 will use the same
Bit 4	ROCV_FREQ_N4	0	frequency ratio stated in the Latched FS[4:0] register. When it is set, W312-02 will use the frequency ratio stated in the SEL[4:0] register. W312-02 supports programmable CPU frequency ranging from 50 MHz to 248 MHz. W312-02 will change the output frequency whenever there is an update to either ROCV_FREQ_N[7:0] and ROCV_FREQ_M[6:0]. Therefore, it is recormended to use Word or Block write to update both registers within the sam SMBus bus operation.
Bit 3	ROCV_FREQ_N3	0	
Bit 2	ROCV_FREQ_N2	0	
Bit 1	ROCV_FREQ_N1	0	
Bit 0	ROCV_FREQ_N0	0	

Bit	Name	Default	Pin Description
Bit 7	ROCV_FREQ_SEL	0	ROCV_FREQ_SEL determines the source of the recover frequency when a Watchdog timer time-out occurs. The clock generator will automatically switch to the recovery CPU frequency based on the selection on ROCV_FREQ_SEL. 0 = From latched FS[4:0] 1 = From the settings of ROCV_FREQ_N[7:0] & ROCV_FREQ_M[6:0]
Bit 6	ROCV_FREQ_M6	0	If ROCV_FREQ_SEL is set, W312-02 will use the values programmed in
Bit 5	ROCV_FREQ_M5	0	ROCV_FREQ_N[7:0] and ROCV_FREQ_M[6:0] to determine the recovery CPU output frequency.when a Watchdog timer time-out occurs
Bit 4	ROCV_FREQ_M4	0	The setting of FS_Override bit determines the frequency ratio for CPU, SDRAM, AGP and SDRAM. When it is cleared, W312-02 will use the same
Bit 3	ROCV_FREQ_M3	0	frequency ratio stated in the Latched FS[4:0] register. When it is set, W312-02 will use the frequency ratio stated in the SEL[4:0] register.
Bit 2	ROCV_FREQ_M2	0	W312-02 supports programmable CPU frequency ranging from 50 MHz to
Bit 1	ROCV_FREQ_M1	0	248 MHz. W312-02 will change the output frequency whenever there is an update to
Bit 0	ROCV_FREQ_M0	0	either ROCV_FREQ_N[7:0] and ROCV_FREQ_M[6:0]. Therefore, it is recomended to use Word or Block write to update both registers within the sar SMBus bus operation.

Bit	Name	Default	Pin Description
Bit 7	CPU_FSEL_N7	0	If Prog_Freq_EN is set, W300 will use the values programmed in CPU_FSEL_N[7:0] and CPU_FSEL_M[6:0] to determine the CPU output fre-
Bit 6	CPU_FSEL_N6	0	quency. The new frequency will start to load whenever CPU_FSELM[6:0] is
Bit 5	CPU_FSEL_N5	0	updated. The setting of FS_Override bit determines the frequency ratio for CPU,
Bit 4	CPU_FSEL_N4	0	SDRAM, AGP and SDRAM. When it is cleared, W312 will use the same frequency ratio stated in the Latched FS[4:0] register. When it is set, W31: 02 will use the frequency ratio stated in the SEL[4:0] register.
Bit 3	CPU_FSEL_N3	0	
Bit 2	CPU_FSEL_N2	0	W312-02 supports programmable CPU frequency ranging from 50 MHz to 248 MHz.
Bit 1	CPU_FSEL_N1	0	
Bit 0	CPU_FSEL_N0	0	

Bit	Name	Default	Description
Bit 7	Pro_Freq_EN	0	Programmable output frequencies enabled 0 = disabled 1 = enabled



Bit	Name	Default	Description
Bit 6	CPU_FSEL_M6	0	If Prog_Freq_EN is set, W300 will use the values programmed in
Bit 5	CPU_FSEL_M5	0	CPU_FSEL_N[7:0] and CPU_FSEL_M[6:0] to determine the CPU output fre quency. The new frequency will start to load whenever CPU_FSELM[6:0] is
Bit 4	CPU_FSEL_M4	0	updated. The setting of FS_Override bit determines the frequency ratio for CPU,
Bit 3	CPU_FSEL_M3	0	SDRAM, AGP and SDRAM. When it is cleared, W312-02 will use the same frequency ratio stated in the Latched FS[4:0] register. When it is set, W312 02 will use the frequency ratio stated in the SEL[4:0] register. W312-02 supports programmable CPU frequency ranging from 50 MHz to 248 MHz.
Bit 2	CPU_FSEL_M2	0	
Bit 1	CPU_FSEL_M1	0	
Bit 0	CPU_FSEL_M0	0	

Bit	Pin#	Name	Default	Description
Bit 7	-	Reserved	0	Reserved
Bit 6	-	Reserved	0	Reserved
Bit 5	-	Reserved	0	Reserved
Bit 4	-	Reserved	0	Reserved
Bit 3	-	Reserved	0	Reserved
Bit 2	-	Reserved	0	Reserved
Bit 1	-	Reserved	1	Reserved. Write with '1'
Bit 0	-	Reserved	1	Reserved. Write with '1'

Byte 16: Reserved Register

Bit	Pin#	Name	Default	Description
Bit 7	-	Reserved	0	Reserved
Bit 6	-	Reserved	0	Reserved
Bit 5	-	Reserved	0	Reserved
Bit 4	-	Reserved	0	Reserved
Bit 3	-	Reserved	0	Reserved
Bit 2	-	Reserved	0	Reserved
Bit 1	-	Reserved	0	Reserved



Byte 17: Reserved Register

Bit	Pin#	Name	Default	Description
Bit 7	-	Reserved	0	Reserved
Bit 6	-	Reserved	0	Reserved
Bit 5	-	Reserved	0	Reserved
Bit 4	-	Reserved	0	Reserved
Bit 3	-	Reserved	0	Reserved
Bit 2	-	Reserved	0	Reserved
Bit 1	-	Reserved	0	Reserved

Table 4. Additional Frequency Selections through Serial Data Interface Data Bytes

	Inp	out Conditi	ions			Output Frequency			
FS4	FS3	FS2	FS1	FS0				PLL Gear Constants	
SEL4	SEL3	SEL2	SEL1	SEL0	CPU	3V66	PCI	(G)	
0	0	0	0	0	156.0	78.0	39.0	48.00741	
0	0	0	0	1	154.0	77.0	38.5	48.00741	
0	0	0	1	0	152.0	76.0	38.0	48.00741	
0	0	0	1	1	147.0	73.5	36.8	48.00741	
0	0	1	0	0	144.0	72.0	36.0	48.00741	
0	0	1	0	1	142.0	71.0	35.5	48.00741	
0	0	1	1	0	138.0	69.0	34.5	48.00741	
0	0	1	1	1	136.0	68.0	34.0	48.00741	
0	1	0	0	0	124.0	62.0	31.0	48.00741	
0	1	0	0	1	122.0	61.0	30.5	48.00741	
0	1	0	1	0	117.0	78.0	39.0	48.00741	
0	1	0	1	1	115.0	76.7	38.3	48.00741	
0	1	1	0	0	113.0	75.3	37.7	48.00741	
0	1	1	0	1	108.0	72.0	36.0	48.00741	
0	1	1	1	0	105.0	70.0	35.0	48.00741	
0	1	1	1	1	102.0	68.0	34.0	48.00741	
1	0	0	0	0	Reserved	Reserved	Reserved	Reserved	
1	0	0	0	1	Reserved	Reserved	Reserved	Reserved	
1	0	0	1	0	Reserved	Reserved	Reserved	Reserved	
1	0	0	1	1	200.0	66.6	33.3	48.00741	
1	0	1	0	0	190.0	76.0	38.0	48.00741	
1	0	1	0	1	180.0	72.0	36.0	48.00741	
1	0	1	1	0	170.0	68.0	34.0	48.00741	
1	0	1	1	1	150.0	75.0	37.5	48.00741	
1	1	0	0	0	140.0	70.0	35.0	48.00741	
1	1	0	0	1	120.0	60.0	30.0	48.00741	
1	1	0	1	0	110.0	73.3	33.3	48.00741	
1	1	0	1	1	66.6	66.6	33.3	48.00741	
1	1	1	0	0	200.0	66.6	33.3	48.00741	
1	1	1	0	1	166.6	66.6	33.3	48.00741	
1	1	1	1	0	100.0	66.6	33.3	48.00741	
1	1	1	1	1	133.3	66.6	33.3	48.00741	



Programmable Output Frequency, Watchdog Timer and Recovery Output Frequency Functional Description

The Programmable Output Frequency feature allows users to generate any CPU output frequency from the range of 50 MHz to 248 MHz. Cypress offers the most dynamic and the simplest programming interface for system developers to utilize this feature in their platforms.

The Watchdog Timer and Recovery Output Frequency features allow users to implement a recovery mechanism when

the system hangs or getting unstable. System BIOS or other control software can enable the Watchdog timer before they attempt to make a frequency change. If the system hangs and a Watchdog timer time-out occurs, a system reset will be generated and a recovery frequency will be activated.

All the related registers are summarized in Table 6.

Table 5. Register Sun	nmary
Name	Description
Pro_Freq_EN	Programmable output frequencies enabled 0 = disabled (default) 1 = enabled
	When it is disabled, the operating output frequency will be determined by either the latched value of FS[4:0] inputs or the programmed value of SEL[4:0]. If FS_Override bit is clear, latched FS[4:0] inputs will be used. If FS_Override bit is set, programmed value of SEL[4:0] will be used.
	When it is enabled, the CPU output frequency will be determined by the programmed value of CPUFSEL_N, CPUFSEL_M and the PLL Gear Constant. The program value of FS_Override, SEL[4:0] or the latched value of FS[4:0] will determine the PLL Gear Constant and the frequency ratio between CPU and other frequency outputs
FS_Override	When Pro_Freq_EN is cleared or disabled, 0 = Select operating frequency by FS input pins (default) 1 = Select operating frequency by SEL bits in SMBus control bytes
	When Pro_Freq_EN is set or enabled, 0 = Frequency output ratio between CPU and other frequency groups and the PLL Gear Constant are based on the latched value of FS input pins (default) 1 = Frequency output ratio between CPU and other frequency groups and the PLL Gear Constant are based on the programmed value of SEL bits in SMBus control bytes
CPU_FSEL_N, CPU_FSEL_M	When Prog_Freq_EN is set or enabled, the values programmed in CPU_FSEL_N[7:0] and CPU_FSEL_M[6:0] determines the CPU output frequency. The new frequency will start to load whenever there is an update to either CPU_FSEL_N[7:0] or CPU_FSEL_M[6:0]. Therefore, it is recommended to use Word or Block write to update both registers within the same SMBus bus operation.
	The setting of FS_Override bit determines the frequency ratio for CPU, AGP and PIC. When FS_Override is cleared or disabled, the frequency ratio follows the latched value of the FS input pins. When FS_Override is set or enabled, the frequency ratio follows the programmed value of SEL bits in SMBus control bytes.
ROCV_FREQ_SEL	ROCV_FREQ_SEL determines the source of the recover frequency when a Watchdog timer time-out occurs. The clock generator will automatically switch to the recovery CPU frequency based on the selection on ROCV_FREQ_SEL. 0 = From latched #5[4:0]
ROCV_FREQ_N[7:0], ROCV_FREQ_M[6:0]	1 = From the settings of ROCV_FREQ_N[7:0] & ROCV_FREQ_M[6:0] When ROCV_FREQ_SEL is set, the values programmed in ROCV_FREQ_N[7:0] and ROCV_FREQ_M[6:0] will be used to determine the recovery CPU output frequency when a Watchdog timer time-out occurs
	The setting of FS_Override bit determines the frequency ratio for CPU, AGP and PIC. When it is cleared, the same frequency ratio stated in the Latched FS[4:0] register will be used. When it is set, the frequency ratio stated in the SEL[4:0] register will be used.
	The new frequency will start to load whenever there is an update to either ROCV_FREQ_N[7:0] and ROCV_FREQ_M[6:0]. Therefore, it is recommended to use Word or Block write to update both registers within the same SMBus bus operation.
WD_EN	0 = Stop and re-load Watchdog timer 1 = Enable Watchdog timer. It will start counting down after a frequency change occurs.



Table 5. Register Sum	mary (continued)
Name	Description
WD_TO_STATUS	Watchdog Timer Time-out Status bit 0 = No time-out occurs (READ); Ignore (WRITE) 1 = time-out occurred (READ); Clear WD_TO_STATUS (WRITE)
WD_TIMER[4:0]	These bits store the time-out value of the Watchdog timer. The scale of the timer is determine by the prescaler. The timer can support a value of 150 ms to 4.8 sec when the pre-scaler is set to 150 ms. If the pre-scaler is set to 2.5 sec, it can support a value from 2.5 sec to 80 sec. When the Watchdog timer reaches "0", it will set the WD_TO_STATUS bit.
WD_PRE_SCALER	0 = 150 ms 1 = 2.5 sec
RST_EN_WD	This bit will enable the generation of a Reset pulse when a Watchdog timer time-out occurs. 0 = Disabled 1 = Enabled
RST_EN_FC	This bit will enable the generation of a Reset pulse after a frequency change occurs. 0 = Disabled 1 = Enabled

How to program CPU output frequency?

When the programmable output frequency feature is enabled (Pro_Freq_EN bit is set), the CPU output frequency is determined by the following equation:

Fcpu = G * (N+3)/(M+3)

"N" and "M" are the values programmed in Programmable Frequency Select N-Value Register and M-Value Register, respectively.

"G" stands for the PLL Gear Constant, which is determined by the programmed value of FS[4:0] or SEL[4:0]. The value is listed in *Table 4*. The ratio of (N+3) and (M+3) need to be greater than "1" [(N+3)/(M+3) > 1].

Table 6 lists set of N and M values for different frequency output ranges. This example use a fixed value for the M-Value Register and select the CPU output frequency by changing the value of the N-Value Register.

Table 6. Examples of N and M Value for Different CPU Frequency Range

Frequency Ranges	Gear Constants	Fixed Value for M-Value Register	Range of N-Value Register for Different CPU Frequency
50 MHz-129 MHz	48.00741	93	97 – 255
130 MHz-248 MHz	48.00741	48	127 – 245



Absolute Maximum Ratings

Stresses greater than those listed in this table may cause permanent damage to the device. These represent a stress rating only. Operation of the device at these or any other conditions

above those specified in the operating sections of this specification is not implied. Maximum conditions for extended periods may affect reliability.

Parameter	Description	Rating	Unit
V _{DD} , V _{IN}	Voltage on any pin with respect to GND	-0.5 to +7.0	V
T _{STG}	Storage Temperature	-65 to +150	°C
T _B	Ambient Temperature under Bias	-55 to +125	°C
T _A	Operating Temperature	0 to +70	°C
ESD _{PROT}	Input ESD Protection	2 (min.)	kV

DC Electrical Characteristics: $T_A = 0$ °C to +70°C, $V_{DD} = 3.3V \pm 5\%$ and 2.5V $\pm 5\%$

Parameter	Description		Test Condition	Min.	Тур.	Max.	Unit
Supply Cur	rent			•			
I _{DD}	3.3V Supply Current		CPU =100 MHz Outputs Loaded ^[2]		260		mA
I _{DD}	2.5V Supply Current		CPUCS =100 MHz Outputs Loaded ^[2]		25		mA
Logic Input	ts						
V _{IL}	Input Low Voltage			GND - 0.3		0.8	V
V _{IH}	Input High Voltage			2.0		V _{DD} + 0.3	V
I _{IL}	Input Low Current ^[3]					-25	μA
I _{IH}	Input High Current ^[3]					10	μΑ
Clock Outp	uts						
V _{OL}	Output Low Voltage		I _{OL} = 1 mA			50	mV
V _{OH}	Output High Voltage		I _{OH} = -1 mA	3.1			V
V _{OL}	Output Low Voltage	CPUT_CS, CPUC_CS, CPUT0, CPUC0	Termination to V pull-up (external)	0		0.3	V
V _{OH}	Output High Voltage	CPUT_CS, CPUC_CS, CPUT0, CPUC0	Termination to V pull-up (external)	1.0		1.2	V
I _{OL}	Output Low Current	PCI, AGP	V _{OL} = 1.5V	70	110	135	mA
		REF	V _{OL} = 1.5V	50	70	100	mA
		48 MHz	V _{OL} = 1.5V	50	70	100	mA
		24_48 MHz	V _{OL} = 1.5V	50	70	100	mA
I _{OH}	Output High Current	PCI, AGP	V _{OH} = 1.5V	70	110	135	mA
		REF	V _{OH} = 1.5V	50	70	100	mA
		48 MHz	V _{OH} = 1.5V	50	70	100	mA
		24_48 MHz	V _{OH} = 1.5V	50	70	100	mA

Notes:

- 2. All clock outputs loaded with 6" 60 $\!\Omega$ transmission lines with 20-pF capacitors.
- 3. X1 input threshold voltage (typical) is V_{DD}/2.



DC Electrical Characteristics: $T_A = 0$ °C to +70°C, $V_{DD} = 3.3V \pm 5\%$ and 2.5V $\pm 5\%$ (continued)

Parameter	Description	Description Test Condition Min.		Тур.	Max.	Unit
Crystal Osc	cillator	<u>.</u>				
V _{TH}	X1 Input Threshold Voltage ^[3]	V _{DD} = 3.3V		1.65		V
C _{LOAD}	Load Capacitance, Imposed on External Crystal ^[4]			18		pF
C _{IN,X1}	X1 Input Capacitance ^[5]	Pin X2 unconnected		TBD		pF
Pin Capaci	tance/Inductance	<u>.</u>				
C _{IN}	Input Pin Capacitance	Except X1 and X2			5	pF
C _{OUT}	Output Pin Capacitance				6	pF
L _{IN}	Input Pin Inductance				7	nH

AC Electrical Characteristics

$T_A = 0$ °C to +70°C, $V_{DDQ3} = 3.3V \pm 5$ %, $f_{XTL} = 14.31818$ MHz

AC clock parameters are tested and guaranteed over stated operating conditions using the stated lump capacitive load at the clock output; Spread Spectrum is disabled.

CPU Clock Outputs (CPUT0, CPUC0, CPU_CS)^[6]

			CPU = 100 MHz CPU		l = 133 MHz				
Parameter	Description	Test Condition/Comments	Min.	Тур.	Max.	Min.	Тур.	Max.	Unit
t _R	Output Rise Edge Rate	CPU_CS	1.0		4.0	1.0		4.0	V/ns
t _F	Output Fall Edge Rate	CPU_CS	1.0		4.0	1.0		4.0	V/ns
t _D	Duty Cycle	Measured at 50% point	45		55	45		55	%
t _{JC}	Jitter, Cycle to Cycle				250			250	ps
f _{ST}	Frequency Stabilization from Power-up (cold start)	Assumes full supply voltage reached within 1 ms from power-up. Short cycles exist prior to frequency stabilization.		3			3		ms
Z _o	AC Output Impedance	$V_O = V_X$		50			50		Ω

Notes:

The W312-02 contains an internal crystal load capacitor between pin X1 and ground and another between pin X2 and ground. Total load placed on crystal is 18 pF; this includes typical stray capacitance of short PCB traces to crystal.
 X1 input capacitance is applicable when driving X1 with an external clock source (X2 is left unconnected).
 Refer to Figure 1 for K7 operation clock driver test circuit.



PCI Clock Outputs (Lump Capacitance Test Load = 30 pF)

Parameter	Description	Test Condition/Comments	Min.	Тур.	Max.	Unit
t _P	Period	Measured on rising edge at 1.5V	30			ns
t _H	High Time	Duration of clock cycle above 2.4V	12			ns
t_	Low Time	Duration of clock cycle below 0.4V	12			ns
t _R	Output Rise Edge Rate	Measured from 0.4V to 2.4V	1		4	V/ns
t _F	Output Fall Edge Rate	Measured from 2.4V to 0.4V	1		4	V/ns
t _D	Duty Cycle	Measured on rising and falling edge at 1.5V	45		55	%
t _{JC}	Jitter, Cycle-to-Cycle	Measured on rising edge at 1.5V. Maximum difference of cycle time between two adjacent cycles.			250	ps
t _{SK}	Output Skew	Measured on rising edge at 1.5V			500	ps
t _O	CPU to PCI Clock Skew	Covers all CPU/PCI outputs. Measured on rising edge at 1.5V. CPU leads PCI output.	1.5		4	ns
f _{ST}	Frequency Stabilization from Power-up (cold start)	Assumes full supply voltage reached within 1 ms from power-up. Short cycles exist prior to frequency stabilization.			3	ms
Z _o	AC Output Impedance	Average value during switching transition. Used for determining series termination value.		30		Ω

REF Clock Outputs (Lump Capacitance Test Load = 20 pF)

Parameter	Description	Test Condition/Comments	Min.	Тур.	Max.	Unit
f	Frequency, Actual	Frequency generated by crystal oscillator	14.318			MHz
t _R	Output Rise Edge Rate	Measured from 0.4V to 2.4V	0.5		2	V/ns
t _F	Output Fall Edge Rate	Measured from 2.4V to 0.4V	0.5	0.5		V/ns
t _D	Duty Cycle	Measured on rising and falling edge at 1.5V	45		55	%
f _{ST}	Frequency Stabilization from Power-up (cold start)	Assumes full supply voltage reached within 1 ms from power-up. Short cycles exist prior to frequency stabilization.			3	ms
Z _o	AC Output Impedance	Average value during switching transition. Used for determining series termination value.		40		Ω

48-MHz Clock Output (Lump Capacitance Test Load = 20 pF)

Parameter	Description	Test Condition/Comments		Тур.	Max.	Unit
f	Frequency, Actual	Determined by PLL divider ratio (see m/n below)		48.008		MHz
f _D	Deviation from 48 MHz	(48.008 – 48)/48		+167		
m/n	PLL Ratio	(14.31818 MHz x 57/17 = 48.008 MHz)		57/17		
t _R	Output Rise Edge Rate	Measured from 0.4V to 2.4V	0.5	0.5		V/ns
t _F	Output Fall Edge Rate	Measured from 2.4V to 0.4V	0.5		2	V/ns
t _D	Duty Cycle	Measured on rising and falling edge at 1.5V	45		55	%
f _{ST}	Frequency Stabilization from Power-up (cold start)	Assumes full supply voltage reached within 1 ms from power-up. Short cycles exist prior to frequency stabilization.			3	ms
Z _o	AC Output Impedance	Average value during switching transition. Used for determining series termination value.		40		Ω



24-MHz Clock Output (Lump Capacitance Test Load = 20 pF)

Parameter	Description	Test Condition/Comments	Min. Typ. N		Max.	Unit
f	Frequency, Actual	Determined by PLL divider ratio (see m/n below)		24.004		MHz
f _D	Deviation from 24 MHz	(24.004 – 24)/24		+167		ppm
m/n	PLL Ratio	(14.31818 MHz x 57/34 = 24.004 MHz)		57/34		
t _R	Output Rise Edge Rate	Measured from 0.4V to 2.4V	0.5		2	V/ns
t _F	Output Fall Edge Rate	Measured from 2.4V to 0.4V	0.5		2	V/ns
t _D	Duty Cycle	Measured on rising and falling edge at 1.5V	45		55	%
f _{ST}	Frequency Stabilization from Power-up (cold start)	Assumes full supply voltage reached within 1 ms from power-up. Short cycles exist prior to frequency stabilization.			3	ms
Z _o	AC Output Impedance	Average value during switching transition. Used for determining series termination value.		40		Ω

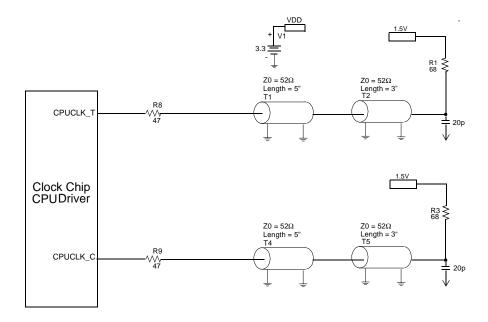


Figure 1. K7 Open Drain Clock Driver Test Circuit.

Ordering Information

Ordering Code	Package Name	Package Type
W312-02	Н	48-pin SSOP (300 mils)

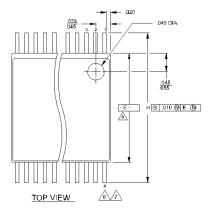
Document #: 38-01087-*A

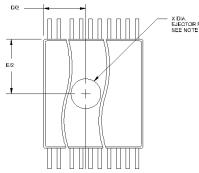
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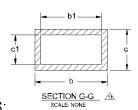


Package Diagram

48-Pin Small Shrink Outline Package (SSOP, 300 mils)







NOTES:

MAXIMUM DIE THICKNESS ALLOWABLE IS .025.

DIMENSIONING & TOLERANCING PER ANSI Y14.5M - 1982.

Y14.5M - 1982

YT14.5 A REFERENCE DATUM.

↑ "D" & "E" ARE REFERENCE DATUM.

↑ "D" & "E" ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE MOLD PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCRED 006 INCHES PER SIDE.

↑ "I" IS THE LENGTH OF TERMINAL FOR SOLDERING TO A SUBSTRATE.

↑ "I" IS THE NUMBER OF TERMINAL POSITIONS.

↑ TERMINAL POSITIONS ARE SHOWN FOR REFERENCE ONLY.

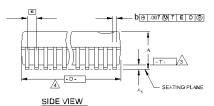
↑ FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITHIN 003 INCHES AT SEATING PLANE.

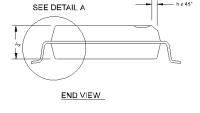
↑ CONTROLLING DIMENSION: INCHES.

10. COUNTRY OF ORIGIN LOCATION AND EJECTOR PIN ON PACKAGE BOTTOM IS OPTIONAL AND DEPENDS ON ASSEMBLY LOCATION.

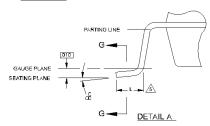
↑ THESE DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN, 005 INCHES AND .010 INCHES FROM THE LEAD TIPS.

12. THIS PART IS COMPLIANT WITH JEDEC SPECIFICATION MO-118, VARIATIONS AA, AB, EXCEPT CHAMFER DIMENSION IN JEDEC SPECIFICATION N. JEDEC SPECIFICATION FOR IS .0157,025".





BOTTOM VIEW



Summary of nominal dimensions in inches:

Body Width: 0.296 Lead Pitch: 0.025 Body Length: 0.625 Body Height: 0.102

s		COMMO	N		NO
-0 WE + S	D	IMENSIO		Νп.	VAF
9	MIN.	NOM.	MAX.	1	ATI
Α	.095	.102	.110		F
A,	.008	.012	.016		P
A.	.088	.090	.092		
ь	.008	.010	.0135		
b	.008	.010	.012		
С	.005	-	.010		
C ₁	.005	.006	.0085		
ōDШe	SEE		4		
E	.292	.296	.299		
е		.025 BSC			
Н	.400	.406	.410		
h	.010	.013	.016		
L	.024	.032	.040	6	
N	SEE VARIATIONS				
X &	.085	.093	.100	10	
o8	0°	5°	8°		
				•	

.720	.725	./30	מכן
THIS	TABLE	IN INCH	ES

6 N

S.	COMMON			NOTE	4			6	
M B	DIMENSIONS		No.	VARI-	D		N		
의 일	MIN.	NOM.	MAX.	'E	ATIONS	MIN.	NOM.	MAX.	
Α	2.41	2.59	2.79		AA	15.75	15.88	16.00	48
A,	0.20	0.31	0.41		AB	18.29	18.42	18.54	56
A.	2.24	2.29	2.34						
b	0.203	0.254	0.343						
b₁	0.203	0.254	0.305			THIS TAI	3LE IN M	IILLIME	ERS
С	0.127	-	0.254						
C ₁	0.127	0.152	0.216						
C ₁	SEE	VARIATION	is	4					
E	7.42	7.52	7.59						
е		0.635 BSC							
H	10.16	10.31	10.41						
h	0.25	0.33	0.41						
L	0.61	0.81	1.02						
N	SEE VARIATIONS			6					
X	2.16	2.36	2.54	10					
æ	0°	5°	8°						

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